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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

U.S. Serial No. 10/750,251 ) I hereby certify that this paper (and/or fee)  
Applicants: Young Hun Seo ) is being deposited with the United States  
Title: Method For Fabricating ) Postal Service as first class mail in an  
Silicon on Insulator Substrates ) envelope addressed to:  
For Use In Semiconductor ) Mail Stop Amendment  
Devices ) Commissioner for Patents  
Filed: December 31, 2003 ) P.O. Box 1450  
 ) Alexandria, VA 22313-1450  
 ) on this date:  
TC/AU: 2826 ) Dated: August 12, 2005  
Examiner: Pert )  
Docket No.: 20059/PIA31199 )  
 ) Mark C. Zimmerman  
 ) Registration No. 44,006

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO THE OFFICE ACTION DATED MAY 12, 2005

Dear Sir:

Please enter the following amendments and consider the following remarks.

**Changes to the Specification** begin on page 2 of this paper.

**The Status of the Claims** is reflected in the listing of claims that begins on page 3 of this paper.

**Remarks** begin on page 4 of this paper.